



# BZT52C2V0 - BZT52C39

#### SURFACE MOUNT ZENER DIODE

#### Features

- Planar Die Construction
- 500mW Power Dissipation
- General Purpose, Medium Current
- Ideally Suited for Automated Assembly Processes
- Lead, Halogen and Antimony Free, RoHS Compliant
  "Green" Device (Notes 3 and 4)
- Qualified to AEC-Q101 Standards for High Reliability

## **Mechanical Data**

- Case: SOD-123
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe)
- Polarity: Cathode Band
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.010 grams (approximate)



Top View

#### Maximum Ratings @T<sub>A</sub> = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.

or capacitance load, derate current by 20%.								
Characteristic	Symbol	Value	Unit					
Forward Voltage @ I <sub>F</sub> = 10mA	VF	0.9	V					

## Thermal Characteristics

Notes:

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 1)	PD	500	mW
Thermal Resistance, Junction to Ambient Air (Note 1)	R <sub>0JA</sub>	350	°C/W
Thermal Resistance, Junction to Lead (Note 2)	R <sub>θJL</sub>	150	°C/W
Operating and Storage Temperature Range	T <sub>J,</sub> T <sub>STG</sub>	-65 to +150	°C

1. Device mounted on FR-4 substrate, single-sided PCB with suggested pad layout.

2. Thermal Resistance measurement obtained via infrared scan method.

3. No purposefully added lead. Halogen and Antimony Free.

 Product manufactured with Data Code V9 (week 33, 2008) and newer are built with Green Molding Compound. Product manufactured prior to Date Code V9 are built with Non-Green Molding Compound and may contain Halogens or Sb<sub>2</sub>O<sub>3</sub> Fire Retardants.

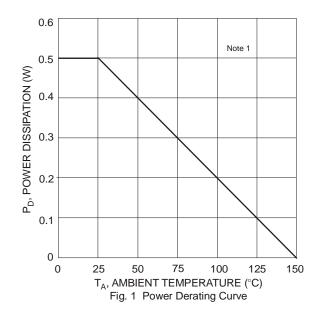


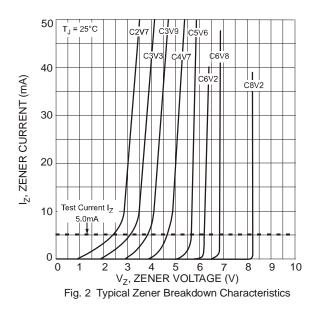
Type Number	Marking Codes	Zener Voltage Range (Note 6)				Maximum Zener Impedance (Note 5)				Maximum Reverse Current (Note 6)		Typical Temperature Coefficient @ Izтc	
(Note 4)			Vz @ Izī		Izt	Z <sub>ZT</sub> @ I <sub>ZT</sub>	Z <sub>ZK</sub> @ I <sub>ZK</sub>	Izĸ	IR	@ V <sub>R</sub>	mV/°C		
		Nom (V)	Min (V)	Max (V)	mA	2	2	mA	uA	v	Min	Max	mA
BZT52C2V0	WY	2.0	1.91	2.09	5	100	600	1.0	150	1.0	-3.5	0	5
BZT52C2V4	WX	2.4	2.2	2.6	5	100	600	1.0	50	1.0	-3.5	0	5
BZT52C2V7	W1	2.7	2.5	2.9	5	100	600	1.0	20	1.0	-3.5	0	5
BZT52C3V0	W2	3.0	2.8	3.2	5	95	600	1.0	10	1.0	-3.5	0	5
BZT52C3V3	W3	3.3	3.1	3.5	5	95	600	1.0	5.0	1.0	-3.5	0	5
BZT52C3V6	W4	3.6	3.4	3.8	5	90	600	1.0	5.0	1.0	-3.5	0	5
BZT52C3V9	W5	3.9	3.7	4.1	5	90	600	1.0	3.0	1.0	-3.5	0	5
BZT52C4V3	W6, UB	4.3	4.0	4.6	5	90	600	1.0	3.0	1.0	-3.5	0	5
BZT52C4V7	W7	4.7	4.4	5.0	5	80	500	1.0	3.0	2.0	-3.5	0.2	5
BZT52C5V1	W8	5.1	4.8	5.4	5	60	480	1.0	2.0	2.0	-2.7	1.2	5
BZT52C5V6	W9	5.6	5.2	6.0	5	40	400	1.0	1.0	2.0	-2	2.5	5
BZT52C6V2	WA	6.2	5.8	6.6	5	10	150	1.0	3.0	4.0	0.4	3.7	5
BZT52C6V8	WB	6.8	6.4	7.2	5	15	80	1.0	2.0	4.0	1.2	4.5	5
BZT52C7V5	WC	7.5	7.0	7.9	5	15	80	1.0	1.0	5.0	2.5	5.3	5
BZT52C8V2	WD	8.2	7.7	8.7	5	15	80	1.0	0.7	5.0	3.2	6.2	5
BZT52C9V1	WE	9.1	8.5	9.6	5	15	100	1.0	0.5	6.0	3.8	7.0	5
BZT52C10	WF	10	9.4	10.6	5	20	150	1.0	0.2	7.0	4.5	8.0	5
BZT52C11	WG	11	10.4	11.6	5	20	150	1.0	0.1	8.0	5.4	9.0	5
BZT52C12	WH	12	11.4	12.7	5	25	150	1.0	0.1	8.0	6.0	10.0	5
BZT52C13	WI	13	12.4	14.1	5	30	170	1.0	0.1	8.0	7.0	11.0	5
BZT52C15	WJ	15	13.8	15.6	5	30	200	1.0	0.1	10.5	9.2	13.0	5
BZT52C16	WK	16	15.3	17.1	5	40	200	1.0	0.1	11.2	10.4	14.0	5
BZT52C18	WL	18	16.8	19.1	5	45	225	1.0	0.1	12.6	12.4	16.0	5
BZT52C20	WM	20	18.8	21.2	5	55	225	1.0	0.1	14.0	14.4	18.0	5
BZT52C22	WN	22	20.8	23.3	5	55	250	1.0	0.1	15.4	16.4	20.0	5
BZT52C24	WO	24	22.8	25.6	5	70	250	1.0	0.1	16.8	18.4	22.0	5
BZT52C27	WP	27	25.1	28.9	2	80	300	0.5	0.1	18.9	21.4	25.3	2
BZT52C30	WQ	30	28.0	32.0	2	80	300	0.5	0.1	21.0	24.4	29.4	2
BZT52C33	WR	33	31.0	35.0	2	80	325	0.5	0.1	23.1	27.4	33.4	2
BZT52C36	WS	36	34.0	38.0	2	90	350	0.5	0.1	25.2	30.4	37.4	2
BZT52C39	WT	39	37.0	41.0	2	130	350	0.5	0.1	27.3	33.4	41.2	2

# **Electrical Characteristics** @T<sub>A</sub> = 25°C unless otherwise specified

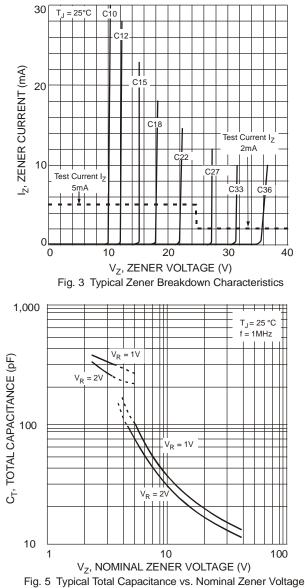
Notes: 5. f = 1kHz.

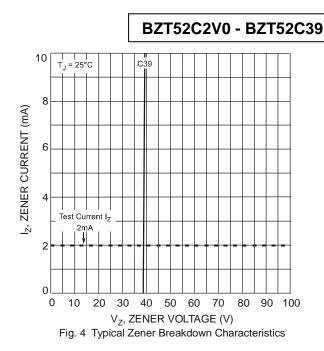
6. Short duration pulse test used to minimize self-heating effect.











### Ordering Information (Note 7)

Part Number	Case	Packaging
(Type Number)-7-F (Note 8)	SOD-123	3000/Tape & Reel
(Type Number)-13-F (Note 9)	SOD-123	10,000/Tape & Reel

7. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf. Notes:

Add "-7-F" to the appropriate type number in Electrical Characteristics Table, example: 6.2V Zener = BZT52C6V2-7-F.
 Add "-13-F" to the appropriate type number in Electrical Characteristics Table, example: 20V Zener = BZT52C20-13-F.

#### **Marking Information**

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xx = Product Type Marking Code (See Electrical Characteristics Table)

YM = Date Code Marking

Y = Year (ex: N = 2002)

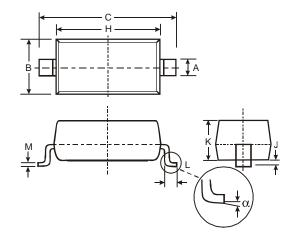
M = Month (ex: 9 = September)

Date Code K	ey						-	(		- /				
Year	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012	2013	2014	2015
Code	Ν	Р	R	S	Т	U	V	W	Х	Υ	Z	А	В	С
Month	Jan	Feb	М	ar	Apr	Мау	Jun	Jul	Aug	Se	p (	Oct	Nov	Dec
Code	1	2	3	3	4	5	6	7	8	9		0	Ν	D

BZT52C2V0 - BZT52C39 Document number: DS18004 Rev. 33 - 2

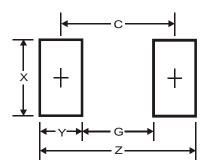


## **Package Outline Dimensions**



		1					
SOD-123							
Dim	Min	Max					
Α	0.55	Тур					
В	1.40	1.70					
С	3.55	3.85					
Н	2.55	2.85					
J	0.00	0.10					
К	1.00 1.35						
L	0.25 0.40						
М	0.10 0.15						
α	0	8°					
All Di	mensions	s in mm					

# Suggested Pad Layout



Dimensions	Value (in mm)
Z	4.9
G	2.5
Х	0.7
Y	1.2
С	3.7



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